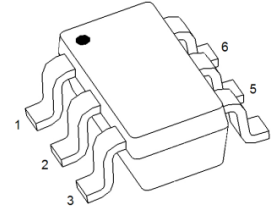


-20V/-4A P-Channel MOSFET
Product Summary

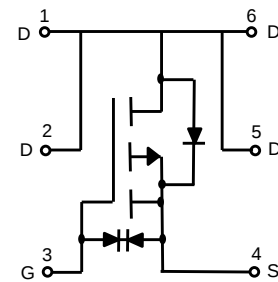
BVDSS	-20.0	V
ID	-4.0	A
RDSON@VGS=-4.5V	33.0	mΩ
RDSON@VGS=-2.5V	45.0	mΩ
RDSON@VGS=-1.8V	64.0	mΩ

SOT-23-6L

Feature

- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- ESD Protected

Application

- Load Switch
- DC/DC Converter


Schematic diagram
Ordering Information:

Product	Package	Marking	Packing
M02P04DG	SOT23-6L	R15	3000PCS/Reel

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V_{DS}	-20	V
Gate - Source Voltage	V_{GS}	± 10	V
Continuous Drain Current ^{1,5}	I_D	-4	A
Pulsed Drain Current ²	I_{DM}	-16	A
Power Dissipation ^{4,5}	P_D	1.2	W
Thermal Resistance from Junction to Ambient ⁵	$R_{\theta JA}$	104	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~ +150	$^\circ\text{C}$

-20V/-4A P-Channel MOSFET
MOSFET ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

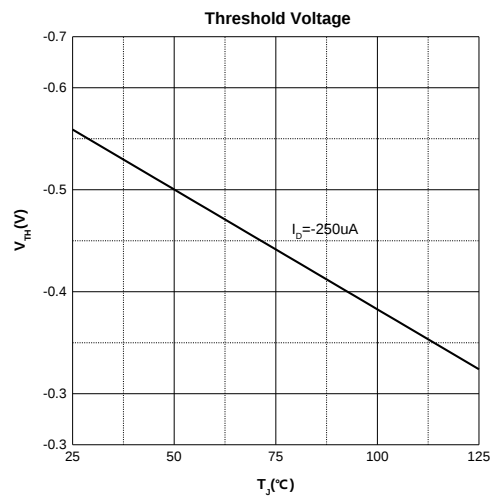
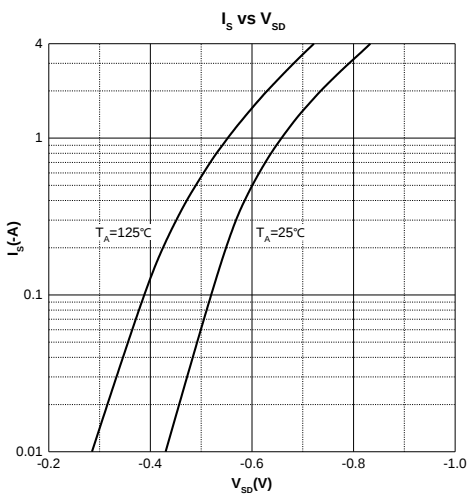
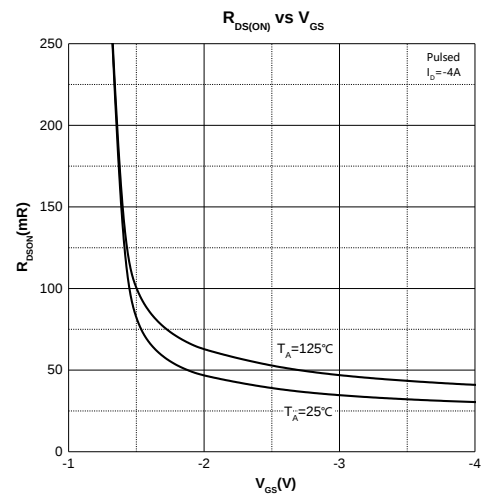
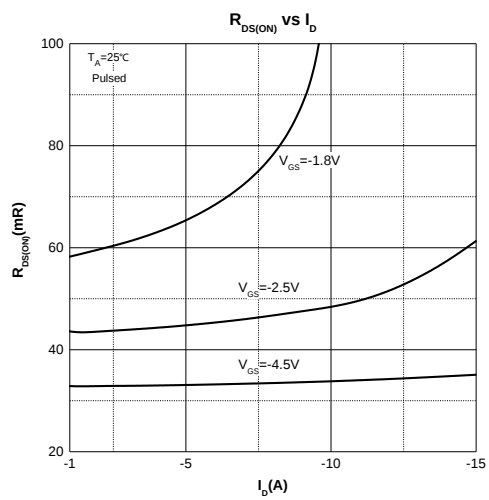
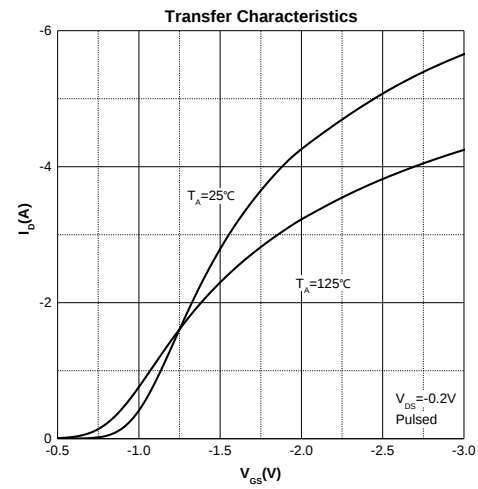
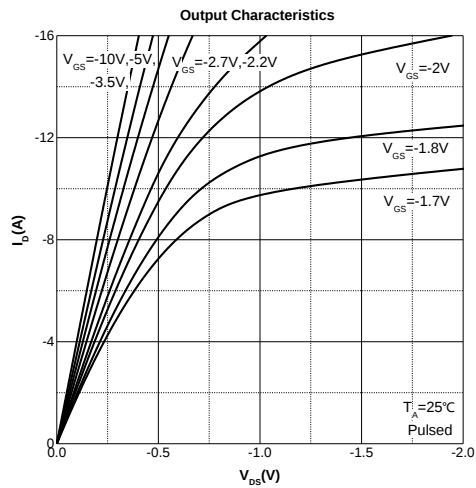
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16V, V _{GS} = 0V			-1	μA
Gate - Body Leakage Current	I _{GSS}	V _{GS} = ±10V, V _{DS} = 0V			±10	μA
On Characteristics ³						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4	-0.65	-1.0	V
Drain-source On-resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -4A		33	50	mΩ
		V _{GS} = -2.5V, I _D = -4A		45	60	
		V _{GS} = -1.8V, I _D = -4A		63	100	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = -10V, V _{GS} = 0V, f = 1MHz		794		pF
Output Capacitance	C _{oss}			139		
Reverse Transfer Capacitance	C _{rss}			124		
Gate Resistance	R _g	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		4.8		Ω
Switching Characteristics						
Total Gate Charge	Q _g	V _{DS} = -20V, V _{GS} = -4.5V, I _D = -2A		11.4		nC
Gate-source Charge	Q _{gs}			1.0		
Gate-drain Charge	Q _{gd}			4.6		
Turn-on Delay Time	t _{d(on)}	V _{DD} = -10V, V _{GS} = -4.5V, R _L = 2.5 Ω, R _G = 3Ω		10		ns
Turn-on Rise Time	t _r			17		
Turn-off Delay Ttime	t _{d(off)}			94		
Turn-off Fall Time	t _f			35		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V _{SD}	V _{GS} = 0V, I _S = -4A			-1.2	V

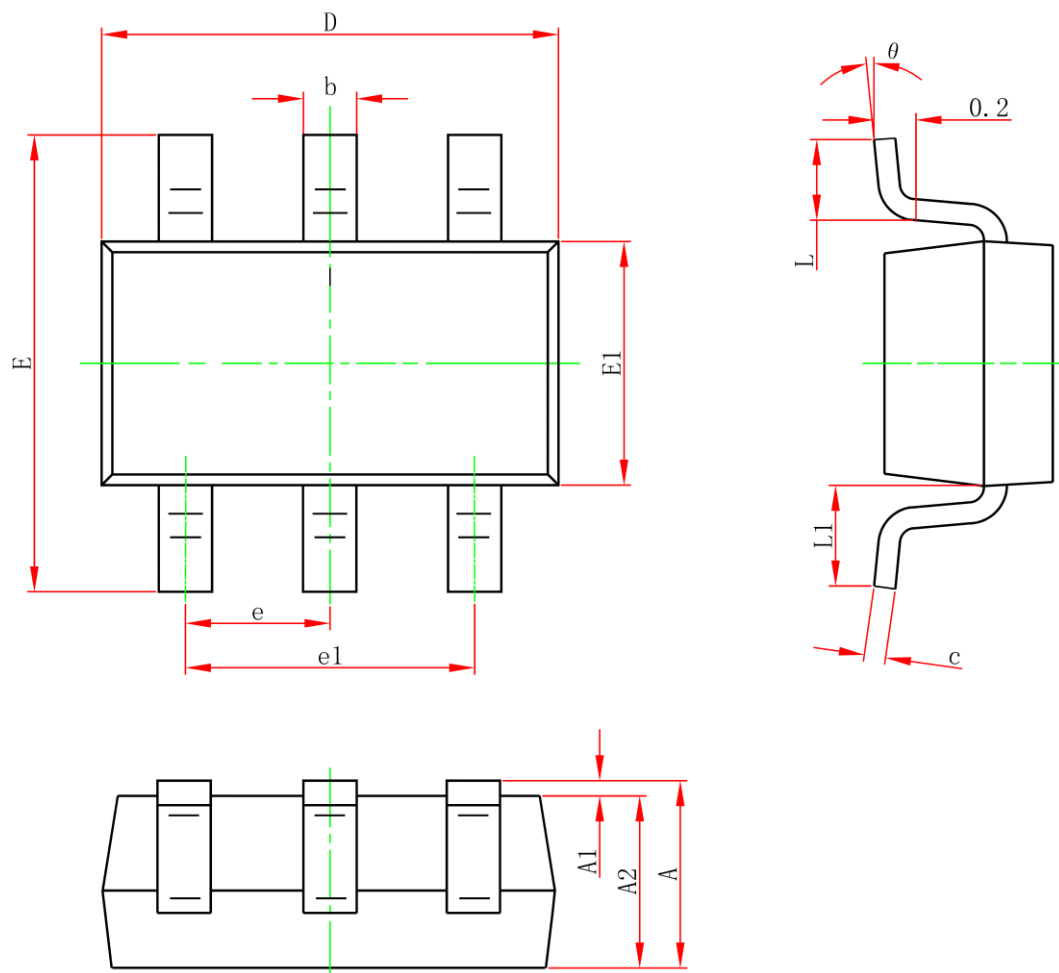
Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.
- 3.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.
- 4.The power dissipation P_D is limited by T_{J(MAX)} = 150°C.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C.

-20V/-4A P-Channel MOSFET

Typical Characteristics



-20V/-4A P-Channel MOSFET
SOT-23-6L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0	0.150	0.000	0.006
A2	1.050	1.250	0.041	0.049
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	2.650	2.950	0.104	0.116
E1	1.500	1.700	0.059	0.067
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
L1	0.600REF		0.024REF	
θ	0°	8°	0°	8°